

## New Product Introduction

# Spartan-3 Platform FPGAs: What Designers Have Been Asking For

## SPARTAN™-3



# Solving the Designer's Dilemma

Commonly-heard requests:

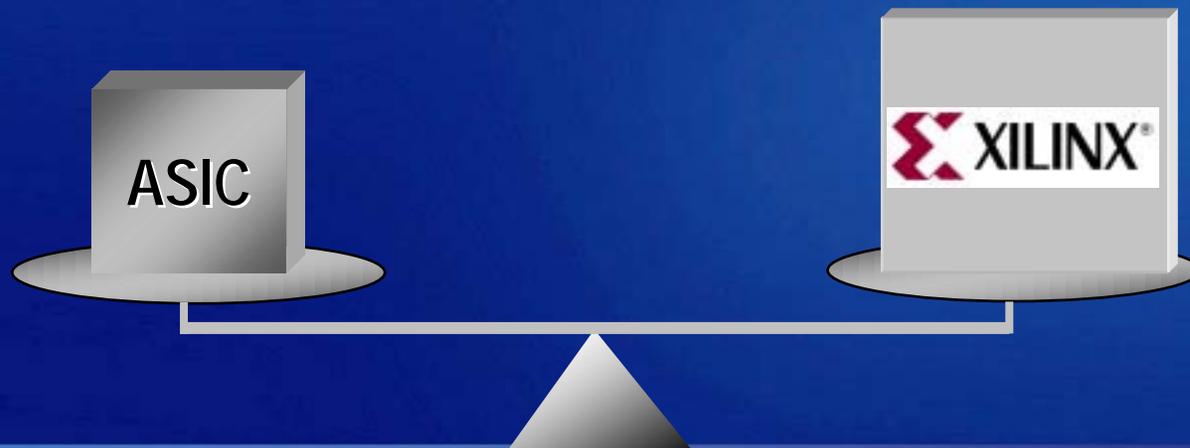
- I need platform level features to get my design done
- I need a solution I can use from prototyping to production
- I need a solution that meets my cost goals

# Solving the Designer's Dilemma

## Let's Weigh the Options

Use a gate array or  
mid-range standard  
cell?

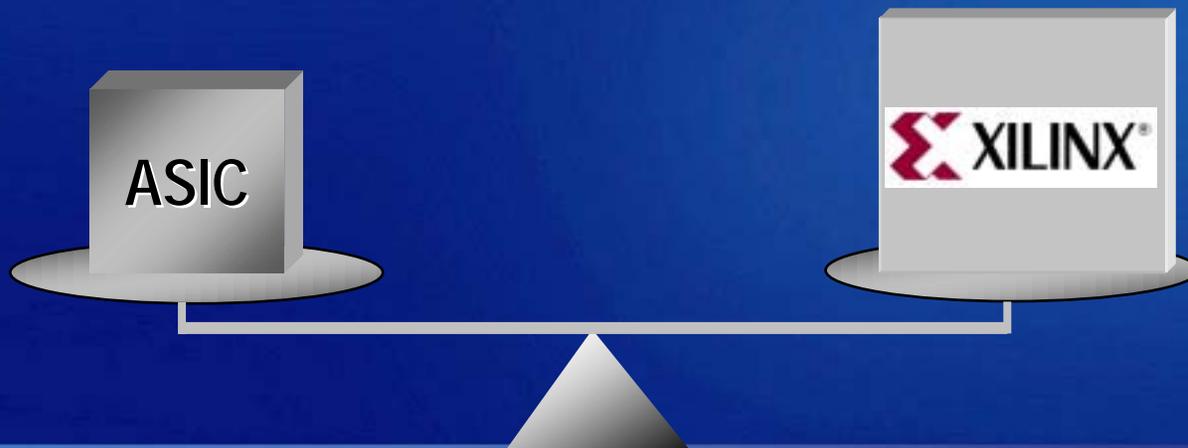
Use an FPGA?



# Weighing ASIC vs. FPGA Value

\$10M engineering cost

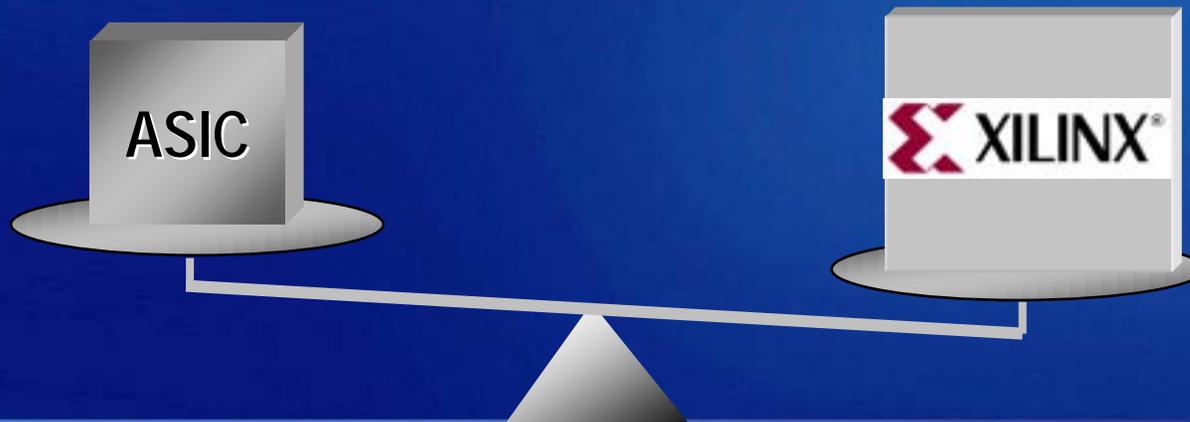
1/10 the development cost



# Weighing ASIC vs. FPGA Value

\$10M engineering cost  
Long development cycle

1/10 the development cost  
1/2 the development time



# Weighing ASIC vs. FPGA Value

\$10M engineering cost  
Long development cycle  
High volume commitment

1/10 the development cost  
1/2 the development cycle  
Re-programmable

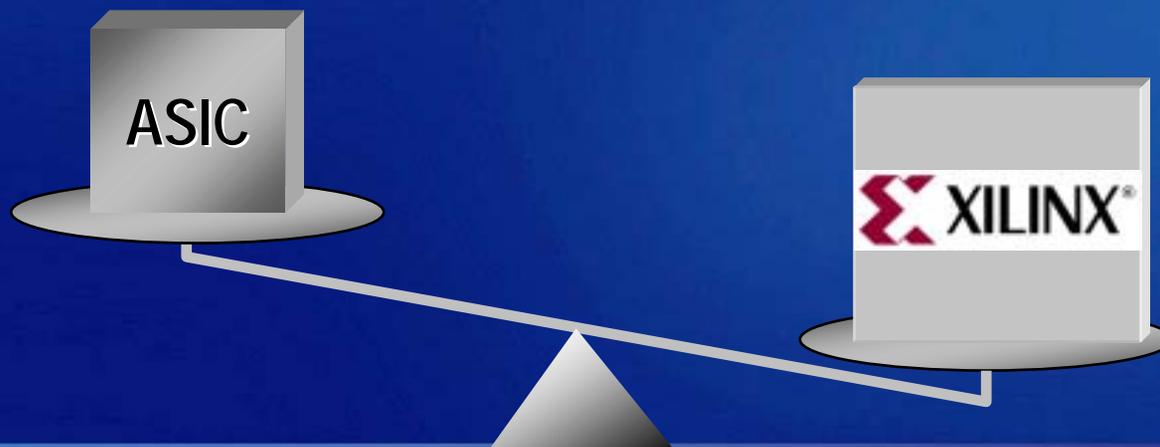


# Weighing ASIC vs. FPGA Value

I like FPGAs, but can I get the density and performance I need at the right cost?

\$10M engineering cost  
Long development cycle  
High volume commitment  
Lowest flexibility

1/10 the development cost  
1/2 the development time  
Re-programmable  
Easiest to use



# Spartan-3 Platform Addresses The Needs of High-Volume Products

## Wide product range

5M System Gates

780 I/O pins

2M bits RAM



## Lowest Cost FPGA

Low cost per gate

Low cost per pin

## Platform Capability

Connectivity

DSP

Embedded  $\mu$ P

# Spartan-3 FPGA Family

Expanded Density Range Up To 75K Logic Cells



# The Spartan-3 Platform: A New Class of Spartan FPGAs



**Embedded XtremeDSP Functionality**  
18 Bit + 18 Bit → X → 36 Bit

**Advanced FPGA Logic**  
90nm

**Digital Clock Management**  
DCM

**High Performance Sync Dual-Port™ RAM**  
BRAM

**SelectIO™-Ultra Technology**

**Staggered Pad Technology**  
Migration with Staggered Pads

**XCITE Digitally Controlled Impedance**  
VCC0, Zx, VCC0

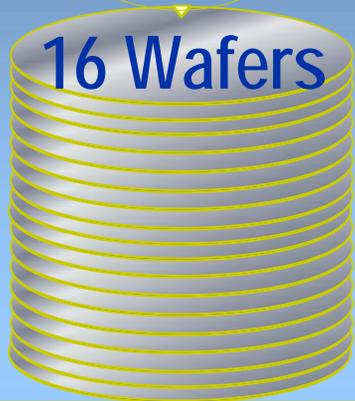
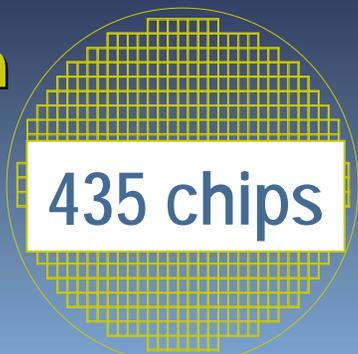
**Partners:** ISE5, LogiCORE, Alliance CORE, Platform Flash, XPERTS, Xilinx Global Services

# Spartan-3 Process Leadership

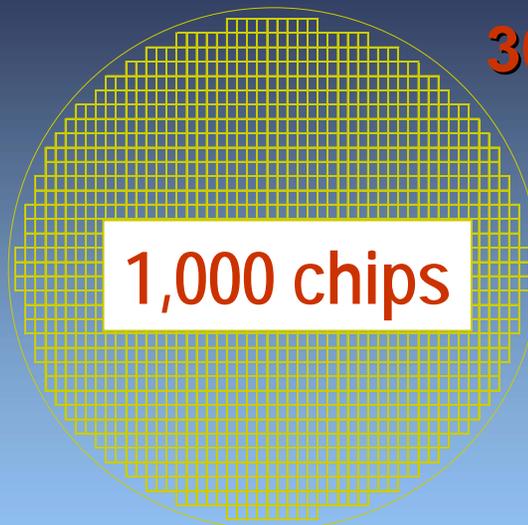
## Resulting in Significant Cost Savings

The larger the die, the greater the savings

200mm

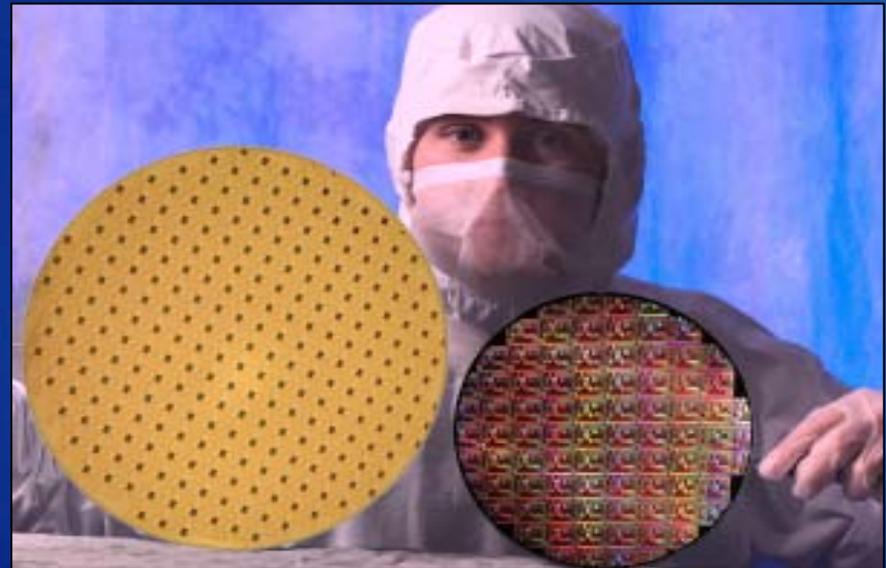


300mm



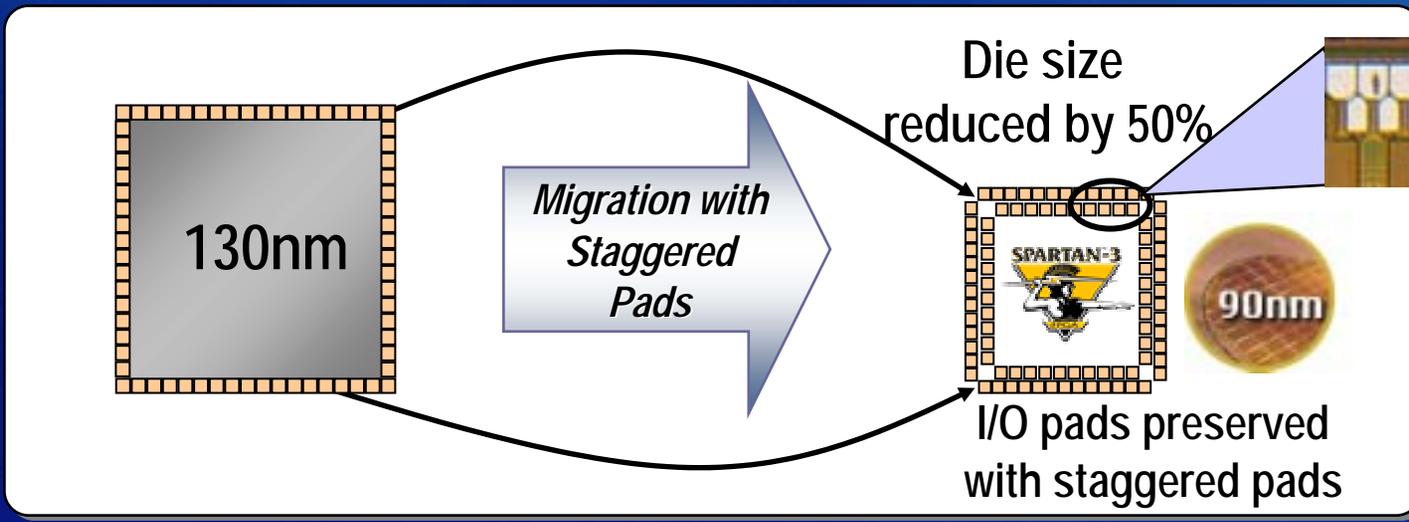
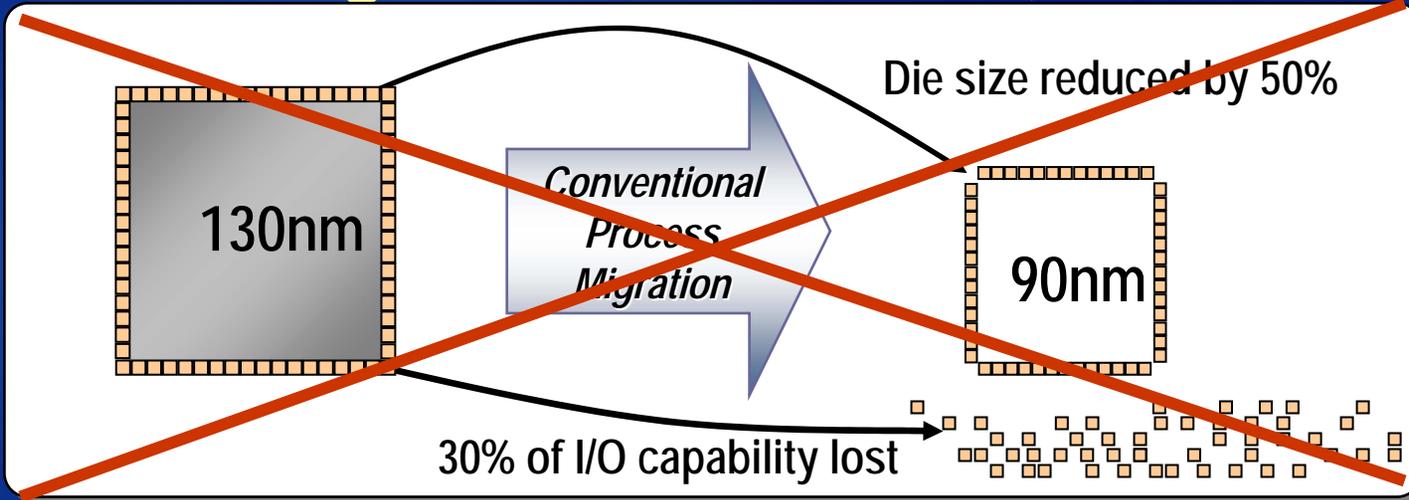
# Xilinx Delivers 90nm FPGAs

- Xilinx ships world's first 90nm FPGA - March 2003
  - Working devices from both IBM & UMC fabs
- 50% smaller die size than 130nm technology
- Increased manufacturing efficiencies from increased die per wafer
- Results in industry's lowest cost per gate and per I/O pin
- Will allow new high volume applications to utilize FPGA advantages



# Maximizing I/O Advantages

## Delivering minimum die size, maximum I/Os

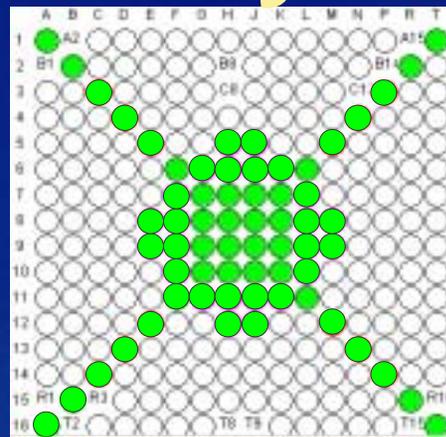


# The Spartan-3 FPGA Advantage

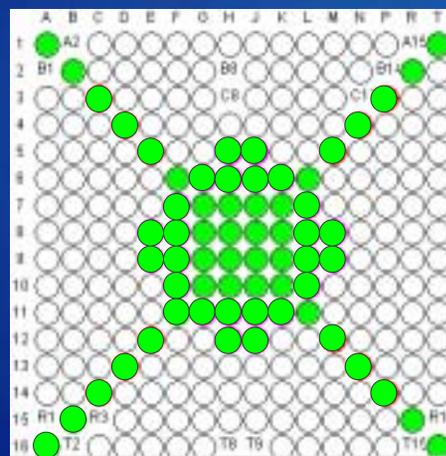
- Spartan-3 devices meet mid-range ASIC requirements
  - Density, I/O pins, and memory
- The Spartan-3 solution delivers flexibility and capability beyond competing FPGA solutions
  - Package and density migration flexibility
  - Industry-leading software and partner support
  - Powerful platform design capabilities
    - Connectivity, DSP, embedded processing

# Guaranteed Density Migration I/O Connectivity

- Seamless migration across densities
- No expensive re-layout
- Position of VCC & GND remains the same
- Higher I/O count for higher density



FT256 package



● VCC & GND ● User I/O

200 K  
System  
Gates



5X  
Density  
Range

1 Million  
System  
Gates

# Migration Over a Wide Density Range

← 100X Density Range →

Device	XC3S50	XC3S200	XC3S400	XC3S1000	XC3S1500	XC3S2000	XC3S4000	XC3S5000
VQ100	61	61						
TQ144	97	97	97					
PQ208	124	141	141					
FT256		173	173	173				
FG456			264	333	333			
FG676				391	487	489		
FG900						565	633	633
FG1156							712	784

TQ144	3 devices, <b>8x</b> density range
PQ208	3 devices, <b>8x</b> density range
FT256	3 devices, <b>5x</b> density range
FG456	3 devices, <b>3x</b> density range
FG676	3 devices, <b>2x</b> density range
FG900	3 devices, <b>2x</b> density range

Density range over million gate devices!



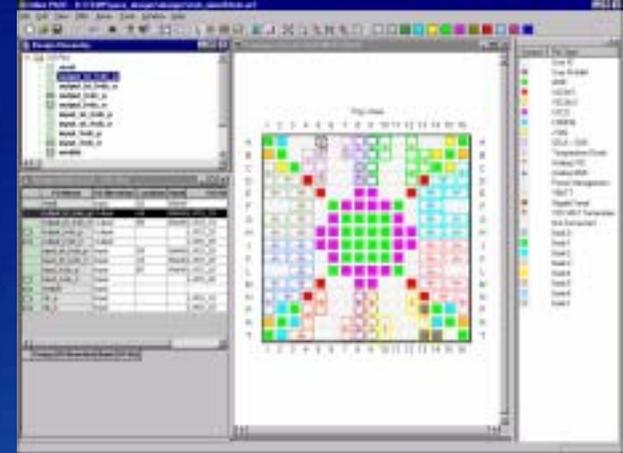
# The ISE Design Tool Advantage

- Xilinx Integrated Software Environment (ISE) tools
  - Continuous technology advancements since 1998
  - 2X runtime improvement every year
    - Now at 3 million gates per hour!
  - Over 150,000 registered users
- Common architecture and tools minimize learning curve
  - Spartan-3 and Virtex-II Pro families both derived from Virtex-II architecture
  - Leverage designer's knowledge and design IP



# Prevalent Design Methodology for Rapid Adoption

- Lower project costs
  - Design & verification times slashed up to 50% compared to ASICs
  - Achieve up to 20% better performance - a “virtual” speed grade advantage
- Redefining “ease-of-use”
  - Streamline critical design bottlenecks
  - Easy access to advanced device features
  - Real-time, in-system debug capabilities with ChipScope Pro



# The Value of Partner Leadership

- Partners deliver their best - first for Xilinx
- Design advances through active collaboration
  - Physical synthesis with incremental design
  - Formal verification
  - HDL rule checking
  - Power analysis
- Offering FPGA design technology once available only for ASIC design



# Lowest Cost Parallel Interconnect Solutions

- Best value in popular cores
  - PCI 32/33 effective cost as low as **\$0.75\***
- Physical interfaces and system elements
  - 23 I/O standards, DDR I/O registers, DCMs
- Pre-engineered solution
  - Drop-in functionality
  - Pre-verified and fully compliant



PCI 32/33 and PCI 64/33

**Real-PCI™**

SPI-3.1 (POS-PHY Level 3)

SPI-4.2 "Lite" (2.5Gbps)

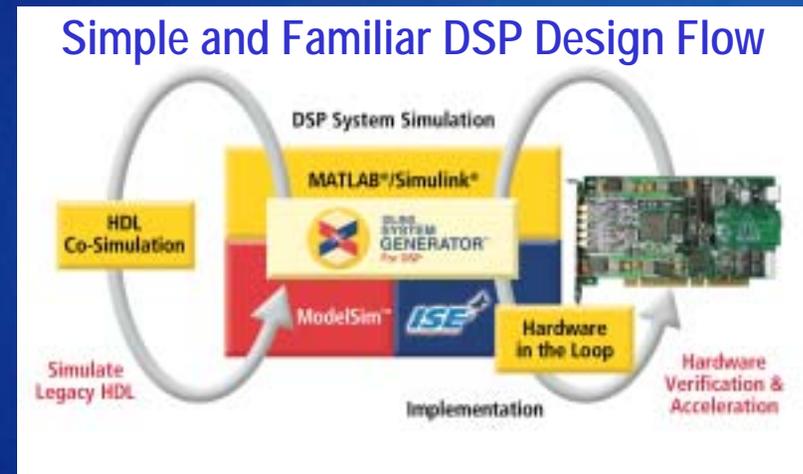


# Unrivaled Cost Points for High Performance DSP

- Up to 330 billion MACs/sec
  - Spartan-3 device under \$100\* delivers up to 276B MACs/sec
- Ideal solution for traditional ASIC-based DSP applications:
  - Digital communications, video/Imaging, & industrial control
- Simple design flow
  - MathWorks (MATLAB/Simulink)
- Complete DSP solution
  - Silicon, software, IP, services, specialists & development systems



Embedded DSP Capability With Up to 104 18bit Multipliers!

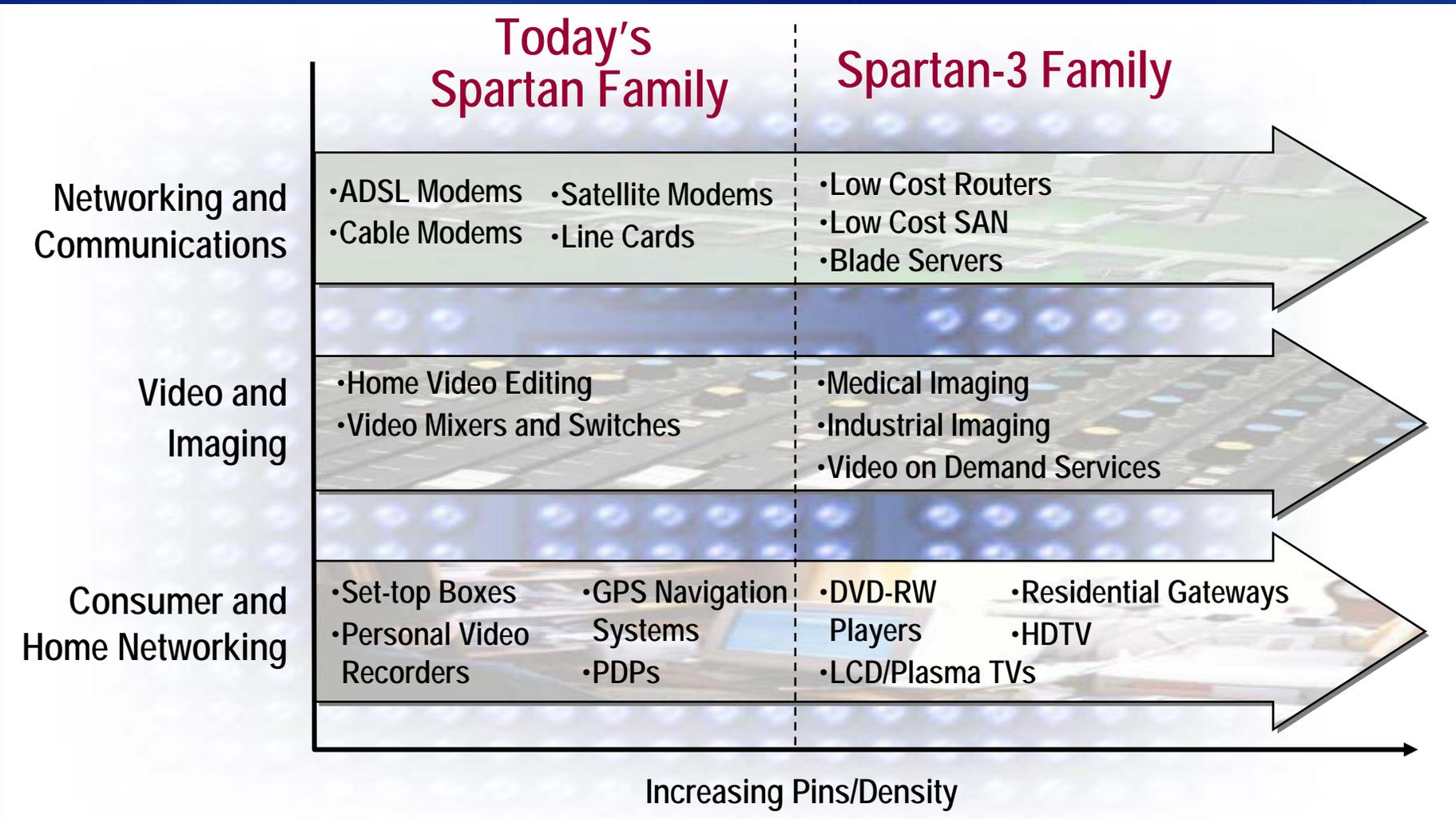


# MicroBlaze & Spartan-3 FPGAs: Industry's Lowest Cost Soft Processor Solution

- Effective cost as low as **\$1.40\***
- Customized controller and peripheral set to meet exact and evolving design requirements
- Complete solution includes HW, SW, tools and design examples
  - Embedded Development Kit (EDK) support offering common development environment with Virtex-II Pro PowerPC-based solutions



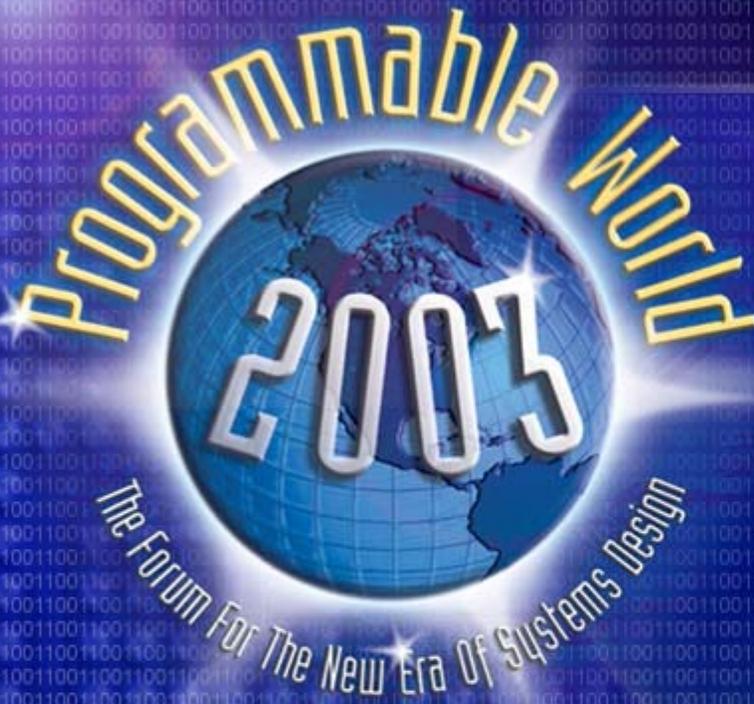
# Wider Range of Markets & Applications



# Summary

- Spartan-3 platform delivers 50K to 5M system gates with lowest cost per gate and cost per I/O
  - 4 Million system gates and 712 I/Os for under \$100\*
  - World's first 90nm FPGA, shipping today
- Spartan-3 delivers platform capabilities in connectivity, DSP, and processing
- Radical increase in density and capability will open up new applications to FPGAs

***Spartan-3 FPGAs: What designers have been asking for***



# Thank You!